IGBT - Field Stop

650 V, 40 A

FGH40N65UFDTU, FGH40N65UFDTU-F085

Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for Automotive Chargers, Inverter, and other applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.8 \text{ V} @ I_C = 40 \text{ A}$
- High Input Impedance
- Fast Switching
- Qualified to Automotive Requirements of AEC-Q101 (FGH40N65UFDTU-F085)
- These Devices are Pb-Free and are RoHS Compliant

Applications

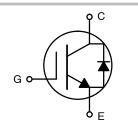
- Automotive Chargers, Converters, High Voltage Auxiliaries
- Inverters, PFC, UPS

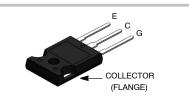


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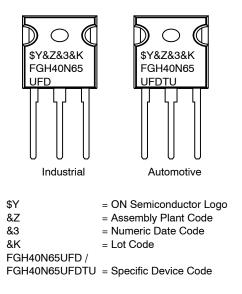
V _{CES}	Ι _C
650 V	40 A





TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		650	V
V_{GES}	Gate to Emitter Voltage		±20	V
Ι _C	Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	80	А
		T _C = 100°C	40	А
I _{CM} (Note 1)	Pulsed Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	120	А
PD	Maximum Power Dissipation	T _C = 25°C	290	W
		$T_C = 100^{\circ}C$	116	W
TJ	Operating Junction Temperature		–55 to +150	°C
T _{STG}	Storage Temperature Range		–55 to +150	°C
ΤL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter		Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	0.43	°C/W
$R_{\theta JC}$ (Diode)) Thermal Resistance, Junction to Case		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Qty per Tube
FGH40N65UFDTU	FGH40N65UFD	TO-247	Tube	30
FGH40N65UFDTU-F085*	FGH40N65UFDTU	TO-247	Tube	30

*Qualified to Automotive Requirements of AEC-Q101.

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
	FERISTICS	-	•	•	1	
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I _C = 250 µA	650	-	_	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	V_{GE} = 0 V, I_{C} = 250 μ A	-	0.6	_	V/°C
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
N CHARACT	ERISTICS					
V _{GE(th)}	G-E Threshold Voltage	I_C = 250 μ A, V_{CE} = V_{GE}	4.0	5.0	6.5	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 40 A, V _{GE} = 15 V,	-	1.8	2.4	V
		I _C = 40 A, V _{GE} = 15 V, T _C = 125°C	-	2.0	_	v
YNAMIC CHA	RACTERISTICS					
C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V,	-	1860	-	pF
C _{oes}	Output Capacitance	f = 1 MHz	-	200	_	pF
C _{res}	Reverse Transfer Capacitance	1	-	65	-	pF
WITCHING C	HARACTERISTICS					
T _{d(on)}	Turn–On Delay Time	$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 40 \text{ A},$	-	23	_	ns
T _r	Rise Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	35	-	ns
T _{d(off)}	Turn–Off Delay Time		-	126	_	ns
Τ _f	Fall Time		-	26	60	ns
Eon	Turn–On Switching Loss		-	1.28	-	mJ
E _{off}	Turn–Off Switching Loss		-	0.50	-	mJ
E _{ts}	Total Switching Loss		-	1.78	-	mJ
T _{d(on)}	Turn–On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	_	21	_	ns
T _r	Rise Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125^{\circ}C$	-	39	-	ns
T _{d(off)}	Turn–Off Delay Time	-	-	131	-	ns
T _f	Fall Time		-	72	-	ns
Eon	Turn-On Switching Loss		_	1.62	-	mJ
E _{off}	Turn-Off Switching Loss	-	-	0.79	-	mJ
E _{ts}	Total Switching Loss		-	2.41	-	mJ
Qg	Total Gate Charge	$V_{CE} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	-	119	-	nC
Q _{ge}	Gate to Emitter Charge	V _{GE} = 15 V	-	14	-	nC
Q _{gc}	Gate to Collector Charge	1	_	64	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Symbol	Parameter	Test Co	Min	Тур	Max	Unit	
V _{FM}	Diode Forward Voltage	I _F = 20 A	$T_{C} = 25^{\circ}C$	-	1.80	2.6	V
			T _C = 125°C	-	1.71	-	
T _{rr}	Diode Reverse Recovery Time	I _F = 20 A, di _F /dt = 200 A/μs	$T_{C} = 25^{\circ}C$	-	65	-	ns
		αιματ – 200 Α/μο	T _C = 125°C	-	215	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$	-	145	-	nC
			$T_C = 125^{\circ}C$	-	775	-	

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25°C unless otherwise noted)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

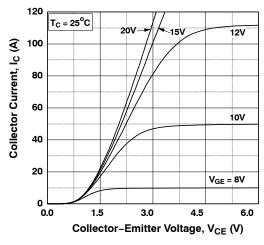
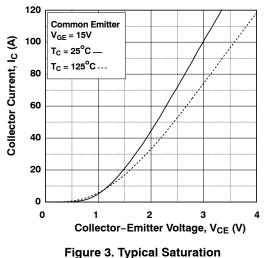


Figure 1. Typical Output Characteristics



Voltage Characteristics

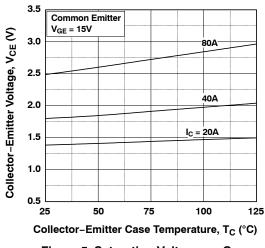


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

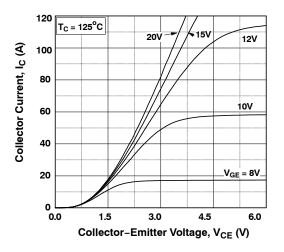


Figure 2. Typical Output Characteristics

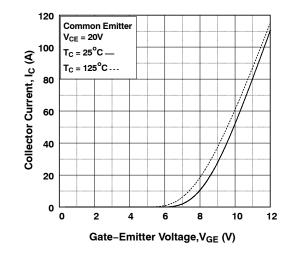


Figure 4. Transfer Characteristics

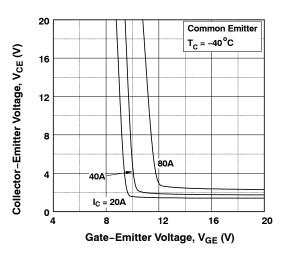


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

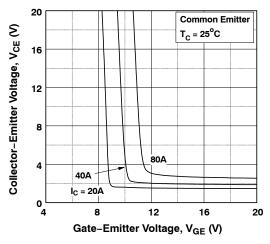


Figure 7. Saturation Voltage vs V_{GE}

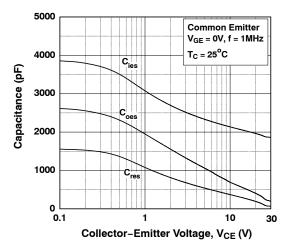
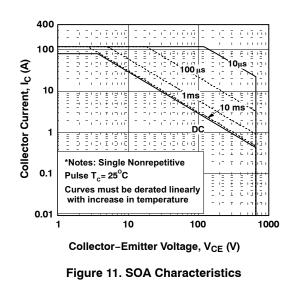


Figure 9. Capacitance Characteristics



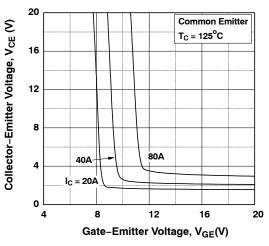


Figure 8. Saturation Voltage vs VGE

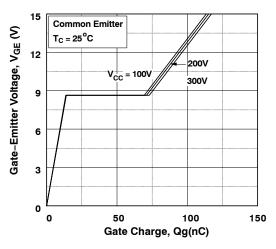
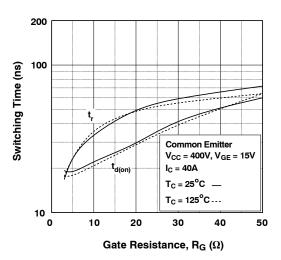
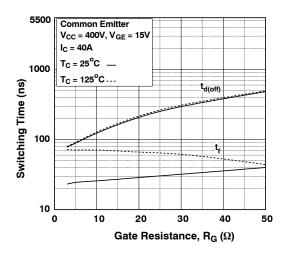


Figure 10. Gate Charge Characteristics

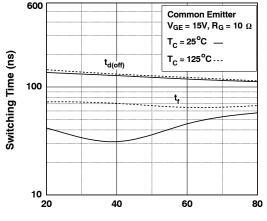




TYPICAL PERFORMANCE CHARACTERISTICS (Continued)







Collector Current, I_C (A)

Figure 15. Turn-off Characteristics vs. Collector Current

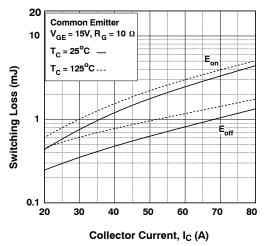


Figure 17. Switching Loss vs. Collector Current

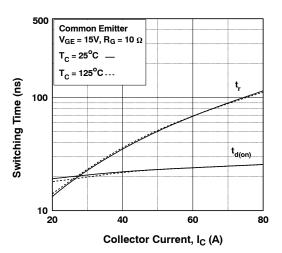
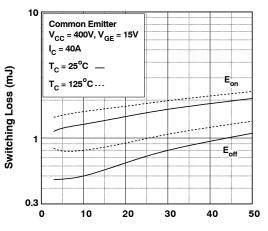


Figure 14. Turn-on Characteristics vs. Collector Current



Gate Resistance, R_{G} (Ω)

Figure 16. Switching Loss vs. Gate Resistance

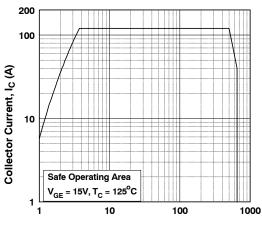
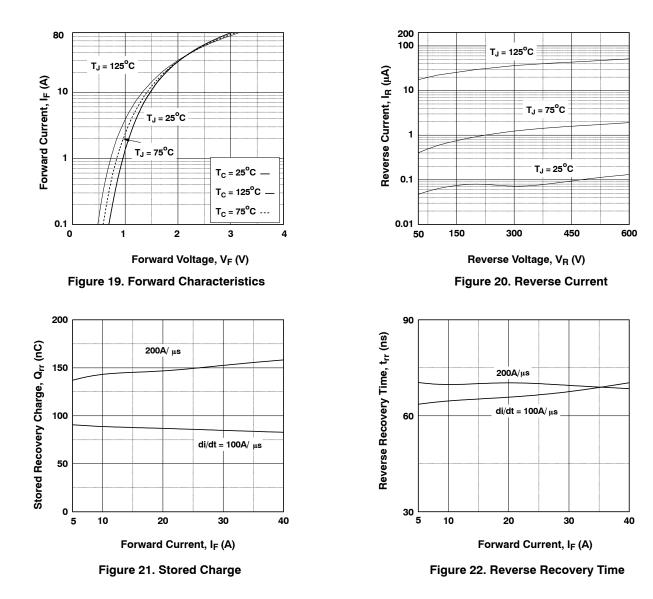




Figure 18. Turn Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



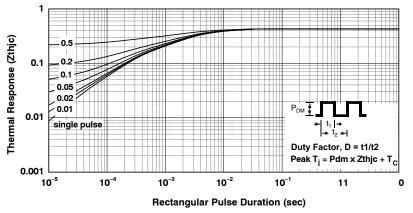
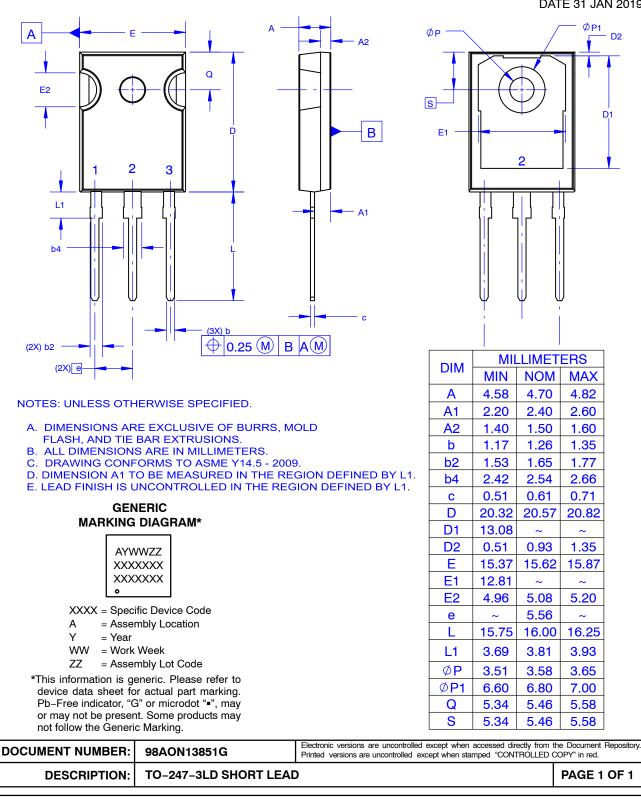


Figure 23. Transient Thermal Impedance of IGBT



TO-247-3LD SHORT LEAD CASE 340CK **ISSUE A**

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